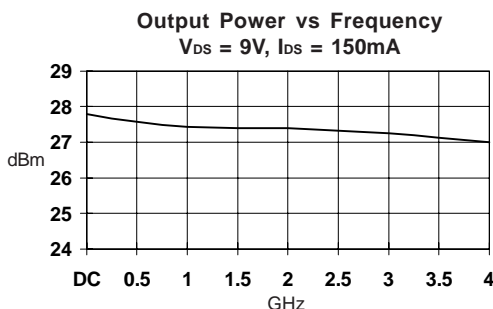


Product Description

Stanford Microdevices' SHF-0186K is a AlGaAs/GaAs Heterostructure FET housed in a low cost surface mount plastic package. HFET technology improves breakdown voltage for high drain voltage operation. Its low Schottky leakage current improves power added efficiency.

These HFETs are an ideal choice as output stages of subscriber products or as drivers for higher power applications. Its high output third order intercept point of +38 dBm makes it suitable for use in high dynamic range requirements.

These devices have 0.5 micron gate lengths with a total gate periphery of 1200 microns. These transistors have proven gold based metallization and nitride passivation.



Electrical Specifications at $T_a = 25^\circ C$

Symbol	Parameters: Test Conditions	Units	Min.	Typ.	Max.
P1dB	Output Power at 1dB Compression: $V_{DS} = 9.0V, I_{DS} = 150mA$	f = 0.1-4.0 GHz dBm	26	27.5	
G1dB	Gain at P1dB: $V_{DS} = 9.0V, I_{DS} = 150mA$	f = 0.9 GHz f = 1.9 GHz dB	17 14	18 16	
PAE	Power Added Efficiency: $V_{DS} = 9.0V, I_{DS} = 150mA$	f = 0.1-4.0 GHz %		40	
TOIP	Third Order Intercept Point: $V_{DS} = 9.0V, I_{DS} = 150mA$	f = 0.1-4.0 GHz dBm		38	
I_{DSS}	Saturated Drain Current: $V_{DS} = 3.0V, V_{GS} = 0V$	mA	210	330	450
Gm	Transconductance: $V_{DS} = 3.0V, V_{GS} = 0V$	mS	130	190	250
V_P	Pinch-Off Voltage: $V_{DS} = 3.0V, I_{DS} = 1mA$	V	-4.0	-2.2	-0.5
V_{BGS}	Gate-to-Source Breakdown Voltage	V	-30	-22	-17
V_{BGD}	Gate-to-Drain Breakdown Voltage	V	-30	-22	-17

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SHF-0186K

DC-4 GHz, 0.5 Watt AlGaAs/GaAs HFET



Product Features

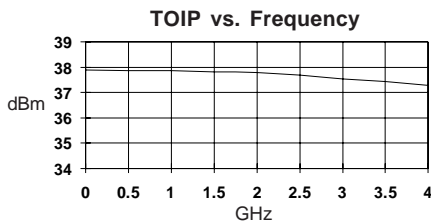
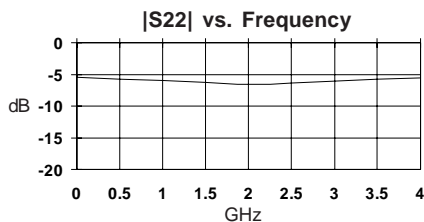
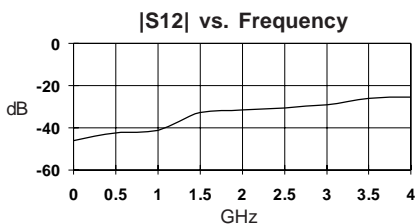
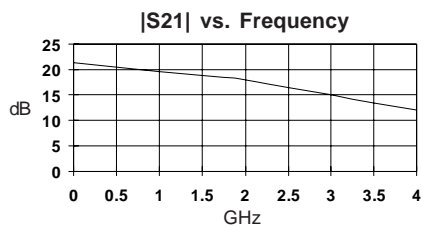
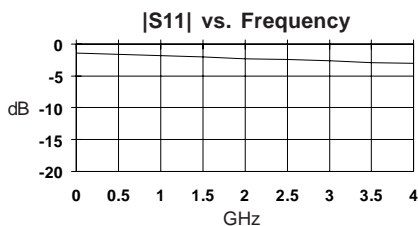
- AlGaAs/GaAs Heterostructure FET Technology
- High Power Added Efficiency
- High Associated Gain : 16 dB typical at 2 GHz
- Low Cost Surface Mount Plastic Package
- Available in Tape and Reel Format

Applications

- Subscriber Products
- Driver for High Power Applications

SHF-0186K DC-4 GHz 0.5 Watt HFET

Typical Performance at 25° C ($V_{ds} = 9V$, $I_{ds} = 150mA$)



Typical S-Parameters $V_{ds} = 9.0V$, $I_{ds} = 150mA$

Freq GHz	S11	S11 Ang	S21	S21 Ang	S12	S12 Ang	S22	S22 Ang
.100	0.891	-12	11.82	177	.005	89	.539	-4
.500	0.928	-64	10.84	150	.023	70	.529	-27
1.00	0.888	-97	9.44	122	.037	63	.477	-48
2.00	0.804	-138	7.94	97	.043	47	.468	-74
3.00	0.813	-167	5.69	70	.049	44	.493	-103
4.00	0.804	172	3.98	52	.053	60	.531	-123

(S-Parameters include the effects of two 1.0 mil diameter bond wires, each 30 mils long, connected to the gate and drain pads on the die)

Absolute Maximum Ratings

Parameter	Symbol	Absolute Maximum
Drain to Source Voltage	V_{DS}	+10V
Gate to Source Voltage	V_{GS}	-17V
Drain Current	I_{DS}	IDSS
RF Input Power	P_{IN}	100 mW
Channel Temperature	T_{CH}	175 C
Storage Temperature	T_{STG}	-65 to +175 C

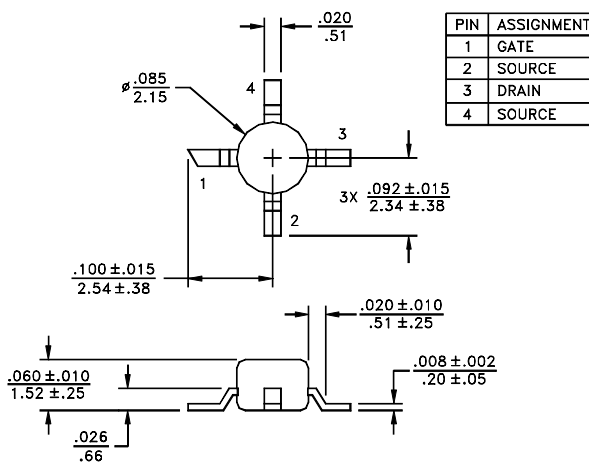
Part Number Ordering Information

Part Number	Devices Per Reel	Reel Size
SHF-0186K-TR1	1000	7"
SHF-0186K-TR2	3000	13"
SHF-0186K-TR3	5000	13"

Notes:

1. Operation of this device above any one of these parameters may cause permanent damage.
2. Mounting Surface Temperature = 25° C

86 Package Outline



Dimensions are in $\frac{\text{in.}}{\text{mm}}$ Tolerances: $\frac{\pm .005 \text{ in.}}{\pm .13 \text{ mm}}$